

# 2SD1755

## Silicon NPN epitaxial planar type

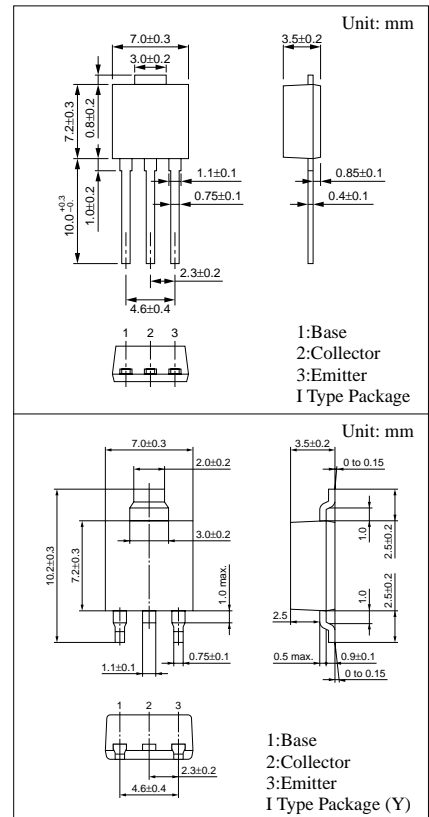
For power amplification with high forward current transfer ratio

### Features

- High forward current transfer ratio  $h_{FE}$  which has satisfactory linearity
- High emitter to base voltage  $V_{EBO}$
- I type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment.

### Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ )

Parameter	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	100	V
Collector to emitter voltage	$V_{CEO}$	60	V
Emitter to base voltage	$V_{EBO}$	15	V
Peak collector current	$I_{CP}$	12	A
Collector current	$I_C$	6	A
Base current	$I_B$	3	A
Collector power dissipation	$P_C$	$T_C=25^\circ\text{C}$	15
		$T_a=25^\circ\text{C}$	1.3
Junction temperature	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$



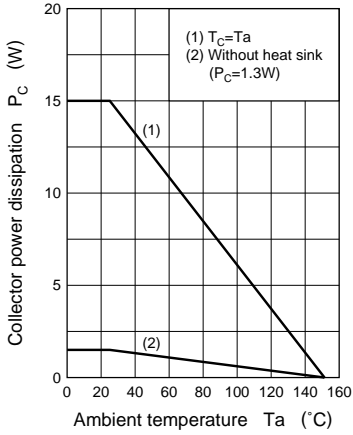
### Electrical Characteristics ( $T_C=25^\circ\text{C}$ )

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	$I_{CBO}$	$V_{CB} = 100\text{V}, I_E = 0$			100	$\mu\text{A}$
Emitter cutoff current	$I_{EBO}$	$V_{EB} = 15\text{V}, I_C = 0$			100	$\mu\text{A}$
Collector to emitter voltage	$V_{CEO}$	$I_C = 25\text{mA}, I_B = 0$	60			V
Forward current transfer ratio	$h_{FE}^*$	$V_{CE} = 4\text{V}, I_C = 1\text{A}$	300		2000	
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = 5\text{A}, I_B = 0.1\text{A}$			0.5	V
Transition frequency	$f_T$	$V_{CE} = 12\text{V}, I_C = 0.5\text{A}, f = 10\text{MHz}$		50		MHz
Turn-on time	$t_{on}$	$I_C = 5\text{A}, I_{B1} = 0.1\text{A}, I_{B2} = -0.1\text{A}, V_{CC} = 50\text{V}$	0.3			$\mu\text{s}$
Storage time	$t_{stg}$			1.5		$\mu\text{s}$
Fall time	$t_f$				0.6	$\mu\text{s}$

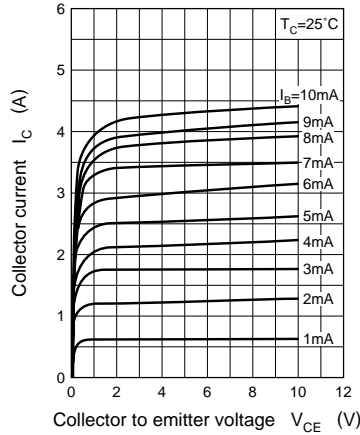
\* $h_{FE}$  Rank classification

Rank	Q	P
$h_{FE}$	300 to 1200	800 to 2000

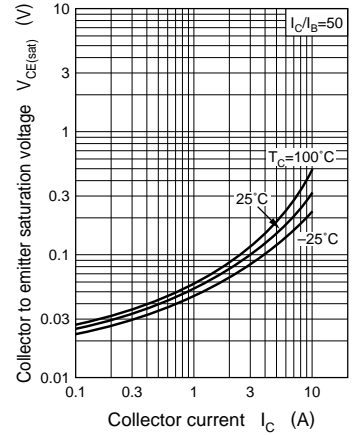
$P_C - T_a$



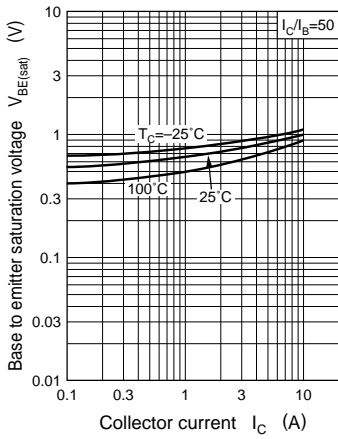
$I_C - V_{CE}$



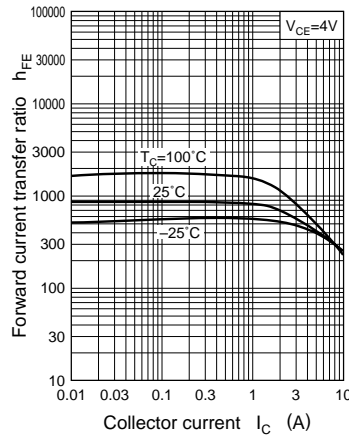
$V_{CE(sat)} - I_C$



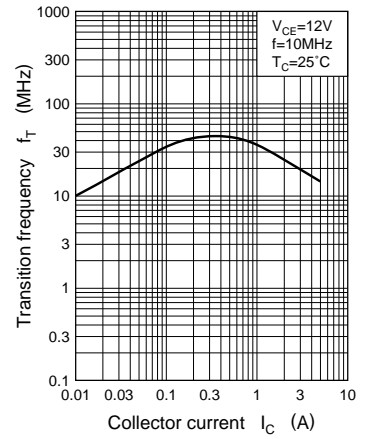
$V_{BE(sat)} - I_C$



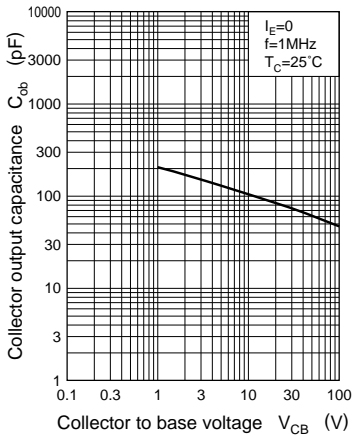
$h_{FE} - I_C$



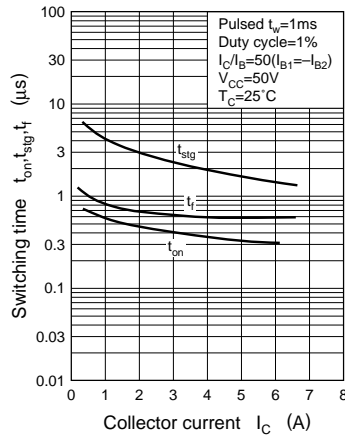
$f_T - I_C$



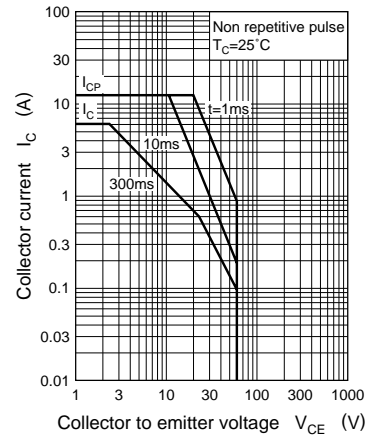
$C_{ob} - V_{CB}$

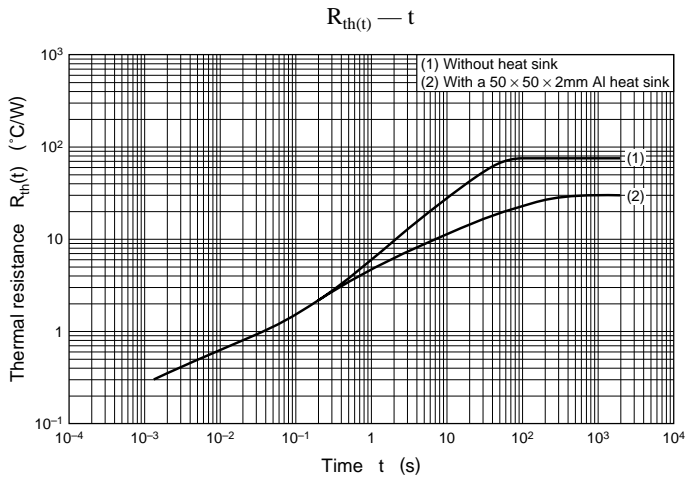


$t_{on}, t_{stg}, t_f - I_C$



Area of safe operation (ASO)





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